	Hit	Search Text	DBs
	s		
14		<pre>interconnect\$4) and ((non\$4last or second\$4last or (L near2 minus near2 one)) near16 (metal\$4 or</pre>	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB
15		(IC or (integrated near5 circuit\$4)) and ((open\$4 or etch\$4 or remov\$4 or blow\$4 or ablat\$4 or (delet\$4 near9 laser)) same fuse) and (fuse same (metal\$4 or conduct\$4 or Cu or copper)) and (terminal or interconnect\$4) and ((non\$4last or second\$4last or (L near2 minus near2 one)) near16 (metal\$4 or conductive) near20 fuse) and (barrier or (diffus\$4 near5 barrier)) and (etch\$4 same (dry or wet)) and ((resist or photoresist) same (expos\$4 or illuminat\$4 or irradiat\$4)) and develop\$4 and pattern\$4	US-PGPUB

	Hit	Search Text	DBs
	S		
16		(IC or (integrated near5 circuit\$4)) and ((open\$4 or etch\$4 or remov\$4 or blow\$4 or ablat\$4 or delet\$4) same laser same fuse) and (fuse same (metal\$4 or conduct\$4 or Cu or copper)) and (terminal or interconnect\$4) and ((non\$4last or second\$4last or (L near2 minus near2 one)) near16 (metal\$4 or conductive) near20 fuse) and (barrier or (diffus\$4 near5 barrier)) and (etch\$4 same (dry or wet)) and ((resist or photoresist) same (expos\$4 or illuminat\$4 or irradiat\$4)) and develop\$4 and pattern\$4	US-PGPUB
17	0	(IC or (integrated near5 circuit\$4)) and ((open\$4 or etch\$4 or remov\$4 or blow\$4 or ablat\$4 or delet\$4) same laser same fuse) and (fuse same (metal\$4 or conduct\$4 or Cu or copper)) and (terminal or intergernect\$4) and ((nen\$4) ast	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT